

### DATA SHEET

# MOS FIELD EFFECT TRANSISTOR 2SK2411, 2SK2411-Z

#### SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The 2SK2411 is N-Channel MOS Field Effect Transistor designed for high speed switching applications.

#### FEATURES

- Low On-Resistance R<sub>DS(on)1</sub> = 40 mΩ MAX. (@ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 15 A) R<sub>DS(on)2</sub> = 60 mΩ MAX. (@ V<sub>GS</sub> = 4 V, I<sub>D</sub> = 15 A)
- Low Ciss Ciss = 1500 pF TYP.
- Built-in G-S Gate Protection Diodes
- High Avalanche Capability Ratings

#### QUALITY GRADE

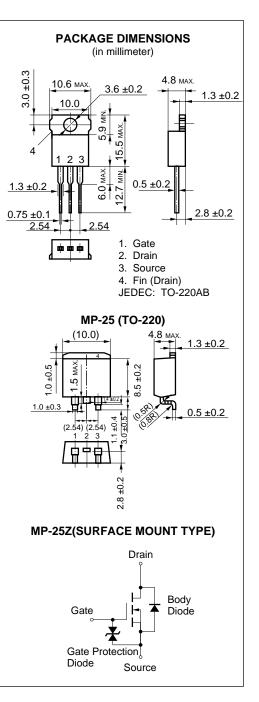
#### Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

	•	,	
Drain to Source Voltage	Vdss	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	D(DC)	±30	А
Drain Current (pulse)*	D(pulse)	±120	А
Total Power Dissipation (Tc = 25 °C)	Pt1	75	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	<b>P</b> T2	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current**	las	30	А
Single Avalanche Energy**	Eas	90	mJ
* PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1 %			
		-	



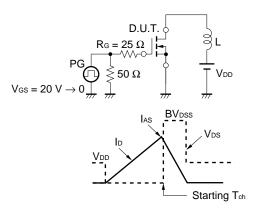


The information in this document is subject to change without notice.

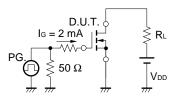
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)1		31	40	mΩ	Vgs = 10 V, Id = 15 A
Drain to Source On-Resistance	RDS(on)2		40	60	mΩ	Vgs = 4 V, Id = 15 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	1.0	1.5	2.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	y <sub>fs</sub>	15	27		S	Vds = 10 V, Id = 15 A
Drain Leakage Current	Ibss			10	μΑ	Vds = 60 V, Vgs = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 V, V_{DS} = 0$
Input Capacitance	Ciss		1500		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		720		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		190		pF	f = 1 MHz
Turn-On Delay Time	td(on)		20		ns	I <sub>D</sub> = 15 A
Rise Time	tr		260		ns	$V_{GS(on)} = 10 V$
Turn-Off Delay Time	td(off)		130		ns	VDD = 30 V
Fall Time	tr		150		ns	R <sub>G</sub> = 10 Ω
Total Gate Charge	QG		50		nC	ID = 30 A
Gate to Source Charge	QGS		5.0		nC	VDD = 48 V
Gate to Drain Charge	QGD		15		nC	Vgs = 10 V
Body Diode Forward Voltage	VF(S-D)		1.1		V	IF = 30 A, VGS = 0
Reverse Recovery Time	trr		110		ns	IF = 30 A, VGS = 0
Reverse Recovery Charge	Qrr		320		nC	di/dt = 100 A/µs

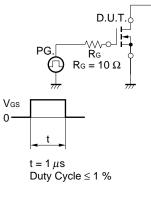
#### Test Circuit 1 Avalanche Capability

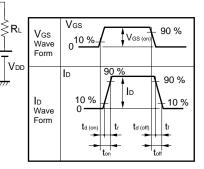


#### Test Circuit 3 Gate Charge



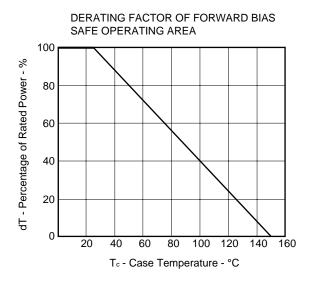
#### Test Circuit 2 Switching Time

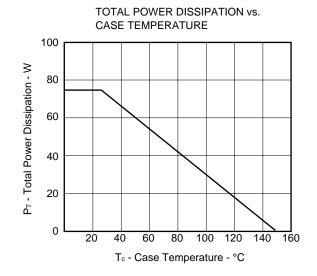




The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

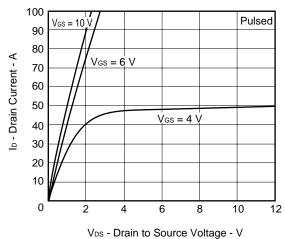
#### TYPICAL CHARACTERISTICS (TA = 25 $^{\circ}$ C)

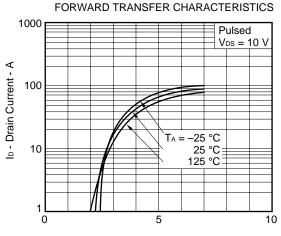




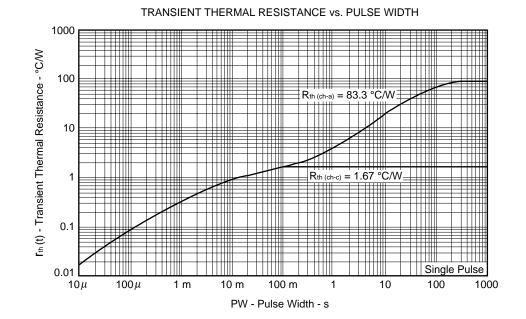
FORWARD BIAS SAFE OPERATING AREA 1000 Py Ip - Drain Current - A วัก D (pulse -tinite 100 ヵ 10 . T₀ = 25 °C 60 Single Pulse 1 0.1 10 100 1 VDS - Drain to Source Voltage - V

DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

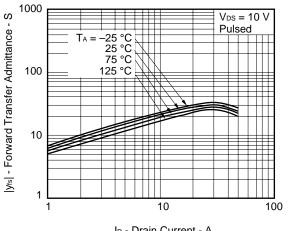




VGS - Gate to Source Voltage - V



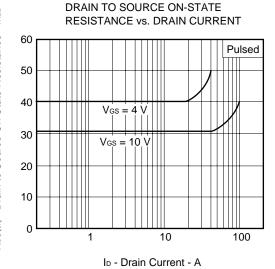
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



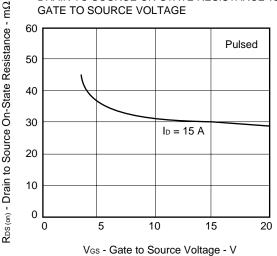
ID - Drain Current - A

 $R_{DS\,(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 

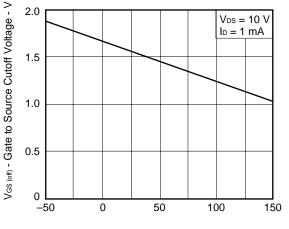
NEC

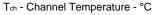


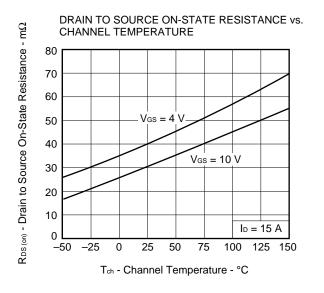
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

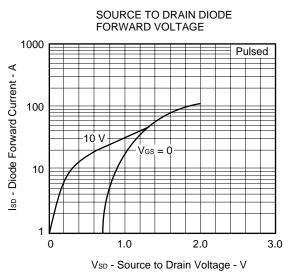








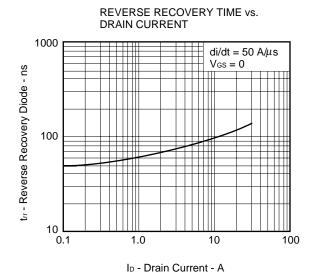




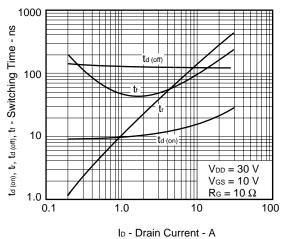
SOURCE VOLTAGE 10000 Vgs = 0 f = 1 MHzCiss, Coss, Crss - Capacitance - pF Ciss 1000 Cos Crss 100 10 10 100 1

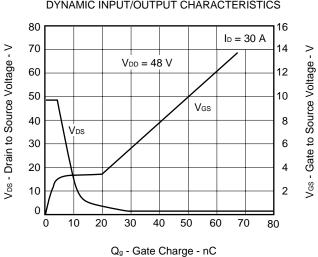
CAPACITANCE vs. DRAIN TO

VDS - Drain to Source Voltage - V

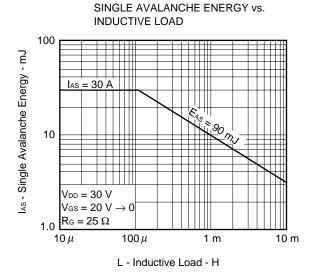


SWITCHING CHARACTERISTICS

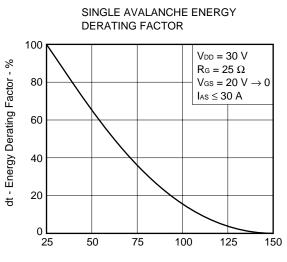




DYNAMIC INPUT/OUTPUT CHARACTERISTICS



NEC



Starting T<sub>ch</sub> - Starting Channel Temperature - °C

#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	C11745E
Quality grade on NEC semiconductor devices.	C11531E
Semiconductor device mounting technology manual.	C10535E
IC package manual.	C10943X
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	X10679E
Power MOS FET features and application switching power supply.	D12971E
Application circuits using Power MOS FET.	D12972E
Safe operating area of Power MOS FET.	D13085E

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

## [MEMO]

NFC

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.

NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

M4 96.5